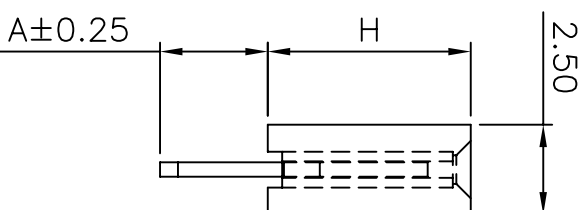
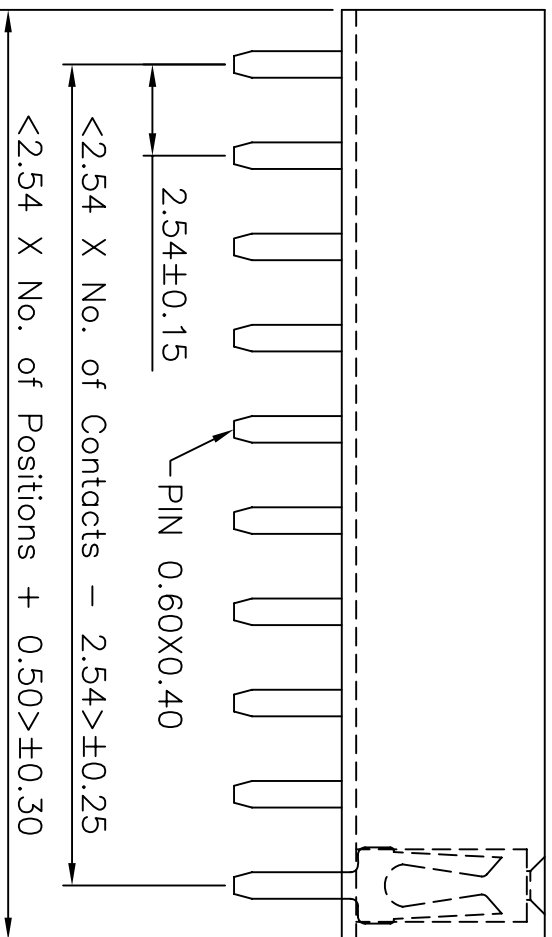


Recommended PC Board Layout

SPECIFICATIONS:

- 1. Current Rating: 3Amp
  - 2. Insulation Resistance: 1000MΩ Min.
  - 3. Dielectric Withstanding: 600V AC/DC
  - 4. Contact Resistance: 20mΩ Max.
  - 5. Operating Temperature: -40°C to +105°C
  - 6. Contact Material: Phosphor Bronze
  - 7. Insulation Material: Polyester, UL 94V-0
  - 8. Plating: Gold, Tin or Selective over Nickel
  - 9. Solderability: IR Reflow 260°C for 10sec  
Wave 230°C for 5~10sec
- Manual solder 350°C for 3~5sec



How to order

FESA01-X X X X X X  
1 2 3 4 5 6 7

- 1. Series No
- 2. No Of Pin Per Row 02-40
- 3. Contact Plating  
G1=Gold flash \*  
T1=Tin  
S1=Gold/tin
- 4. Pin Length  
XXX=Select A  
001=(A=3.0)
- 5. Insulator Height  
A=8.5mm \*  
B=5.7mm
- 6. Insulator Material  
T=Nylon 6T \*  
L=LCP
- 7. Packing  
C=Tube \*

\* for standard



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Website: www.rsk-tech.com  
Email: info@rsk-tech.com

TITLE : Female Header, 2.54 Pitch,  
Single row, Straight Type, H=5.7/8.5

Appd.: Xiao Jian

CHKD.: Wang Zhijun

DR.: Li Guoming

A4

PART NO :FESA01-XXXX

DWG. NO.: FESA01-XXXX

REV.: 1.0 DATE: 2006-05-14

X: ±0.30 X: ±5.0°

XX: ±0.20 XX: ±3.0°

XXX: ±0.15 XXX: ±1.0°

UNIT: mm

SCALE: 1:1 SHEET: 1/1

1.3

1.2

1.1

1.0

REV.

RELEASED

LI GM

DR BY

ECN. NO.

DATE

2006-05-14

2

3

4

5

6

7

8

9

10